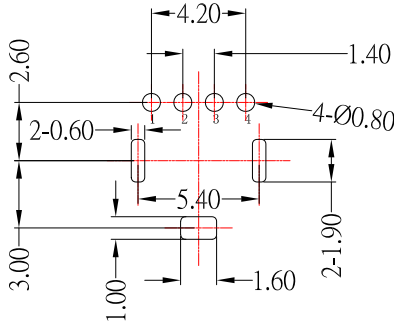
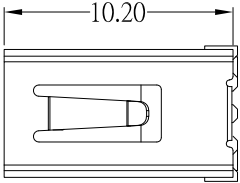


SUA-110P13Bx-xx-S236

SHELL :  
Blank : BRASS  
I : SPCC

鍍層厚度 :  
Blank : 1u"  
2 : 15u"  
3 : 30u"

Color :  
Black : B  
White : W



PCB LAYOUT MOUNTING PATTERN

SPECIFICATIONS

Electrical:

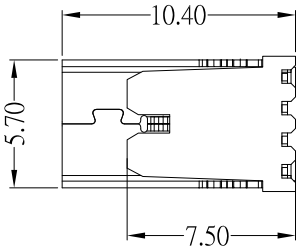
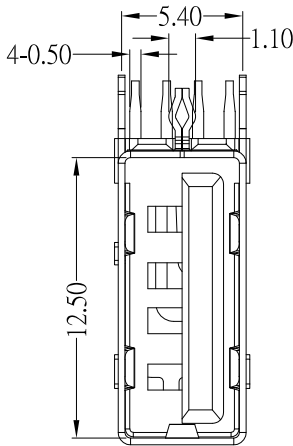
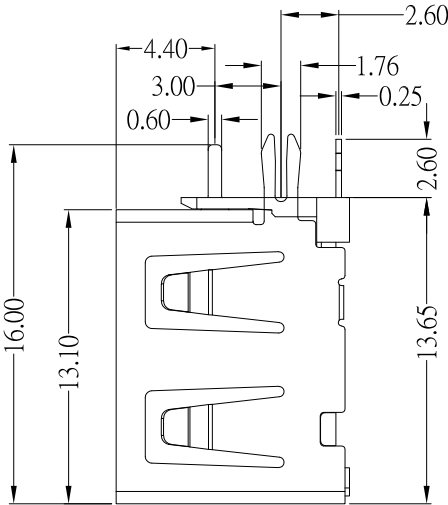
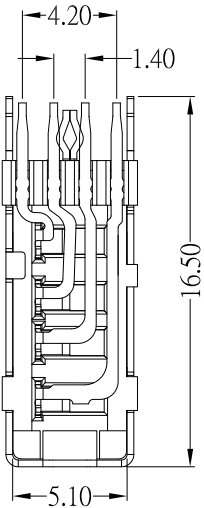
- 1.Rated Current: 2.0 A Max
- 2.Dielectric Withstanding Voltage: AC 500 V / 1MIN
- 3.Insulation Resistance: 1,000 MΩ Min
- 4.Contact Resistance: 30 mΩ Max

Material:

- 1.Housing: PBT
- 2.Contact: PhosphorBronze
- 3.Shell: Brass / Spcc

Finish:

- 1.Contact: Plated Gold in Mating Area ;  
Tin Plated on Solder Balls ;  
Nickel under plated overall
- 2.Shell: Nickel under Plated surface layer



CONTACT

建倚科技股份有限公司  
CONTACT TECHNOLOGY CORP.

TOLERANCE UNLESS  
OTHERWISE STATED :

Up to 5 ±0.2  
Above 5 ~ 15 ±0.3  
Above 15 ~ 30 ±0.4  
Above 30 ~ 50 ±0.5  
Angle ±0.3°

3RD.  
ANGEL'S



UNITS

MM

DRAWN BY: Jack Lu  
CHECKED BY: Jacky Chen  
APPROVED BY: Tony Kao  
DATE: 06/10/26  
DATE: 06/10/26  
DATE: 06/10/26

| MAT'L     | TITLE  | CONNECTOR                     |
|-----------|--------|-------------------------------|
| FINISH    | MODLE  | USB AF 側插短體外殼魚叉腳無捲邊 L=10.40mm |
| SCALE     | 1 : 1  | DWG NO. SUA-110P13Bx-xx-S236  |
| SHEET NO. | 1 of 1 | PART NO. SUA-110P13Bx-xx-S236 |

| ITEM NO. | DESCRIPTION | DRAWN | DATE   |
|----------|-------------|-------|--------|
| 2        | 新增顏色選項      | Jack  | 061026 |
| 1        | 新增尺寸        | Jack  | 042622 |